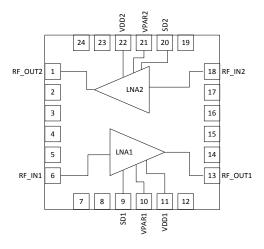


# **RFLA9002**

Dual Low Noise Amplifier Module 698MHz to 960MHz

RFMD's RFLA9002 is a dual Low Noise Amplifier module with external connections to both LNAs. These LNAs feature a shutdown mode to turn off the LNA and provide up to 15dBm drive level without gain expansion and self-biasing in shutdown mode. Noise figure of 1.0dB and P1dB of 0dBm makes this component ideal for receiver input lineups. The RFLA9002 is packaged in a small 4.0mm x 4.0mm leadless laminate MCM. This module is internally matched to  $50\Omega$  on all RF ports making it easy to use with no use with no external matching components required.



Functional Block Diagram

## **Ordering Information**

RFLA9002SQ	Sample bag with 25 pieces
RFLA9002SR	7" Reel with 100 pieces
RFLA9002TR13	13" Reel with 2500 pieces
RFLA9002PCK-410	698MHz to 960MHz PCBA with 5-piece sample bag



Package: MCM, 24-pin, 4.0mm x 4.0mm

#### **Features**

- Frequency Range 698MHz to 960MHz
- Internally Matched to 50Ω on All RF Ports
- Shutdown Mode with +40dB Isolation
- Gain = 16dB per LNA
- Noise Figure of 1.0dB Typical
- Single +4.0V Supply
- Small 24-Pin, 4.0mm x 4.0mm, Multi-Chip Module (MCM)

#### **Applications**

- Cellular Repeaters and Booster Amps
- General Purpose LNA
- ISM Band LNA



## **Absolute Maximum Ratings**

Parameter	Rating	Unit
Supply Voltage	+5.5	$V_{DC}$
Control Voltage	+5.5	$V_{DC}$
DC Supply Current	140	mA
Power Dissipation	770	mW
Max RF Input Power	15	dBm
Operating Temperature (T <sub>CASE</sub> )	-40 to +85	°C
Storage Temperature	-40 to +150	°C
Max Junction Temperature (T <sub>J</sub> )	150	°C
ESD Rating - Human Body Model (HBM)	1000 (Class 1C)	V
Moisture Sensitivity Level	MSL3	



Caution! ESD sensitive device.



RFMD Green: RoHS status based on EU Directive 2011/65/EU (at time of this document revision), halogen free per IEC 61249-2-21, < 1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

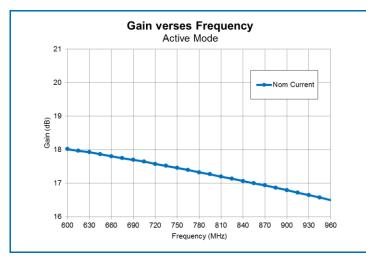
Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

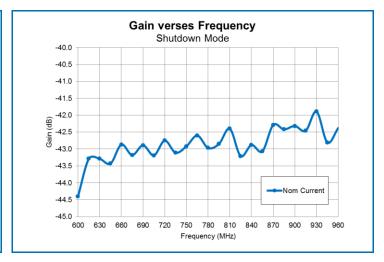
## **Nominal Operating Parameters**

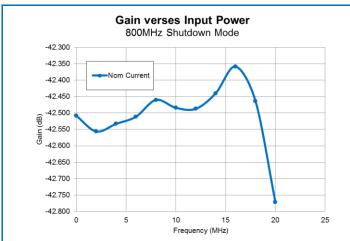
D	Specification					
Parameter	Min	Тур	Max	Unit	Condition	
Individual LNA Performance					T = 25°C, V <sub>CC</sub> = 4V, Standard Application Circuit	
Frequency Range	698		960	MHz		
Gain (On Mode)	16	17.5	19.5	dB	SD = 0V	
Noise Figure		1.0	1.4	dB		
Input P1dB	-5	0		dBm	698MHz	
	-3	0		dBm	880MHz and 960MHz	
Input IP3	1.5	5		dBm		
Gain (Off Mode)		-43		dB	SD = 4V	
Gain Delta	>40			dB	Gain LNA (on mode) – Gain LNA (off mode)	
Input Return Loss		13		dB	SD = 0V	
Output Return Loss		13.5		dB		
Isolation (LNA1 OUT to LNA2 IN)	39	45		dB		
Gain Compression Slope	-1.1	-1	-0.1	dB	Gain compresses monotonically with increased input power once saturated	
Overall Power Supply					T = 25°C, V <sub>CC</sub> = 4V, Standard Application Circuit	
Supply Voltage	3.5	4	5	V		
SD Voltage	0		vcc	V		
Logic High	1.7		VCC	V		
Logic Low	0		0.6	V		
Thermal Resistance		139		°C/W	85°C at 4.5V at 35mA of current	
Current	8	12	20	mA	On Mode, SD = 0V	
	0.01	1	3	mA	Off Mode, SD = 4V	

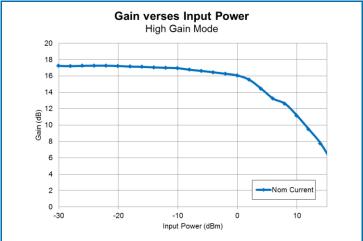


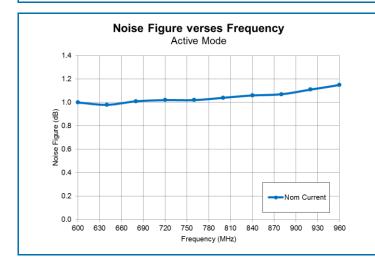
#### Typical Performance: T=25°C, VDD = 4V unless otherwise noted

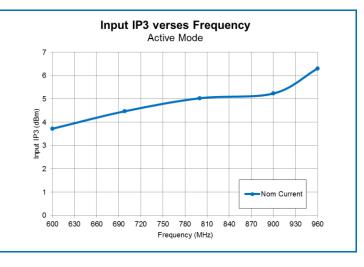






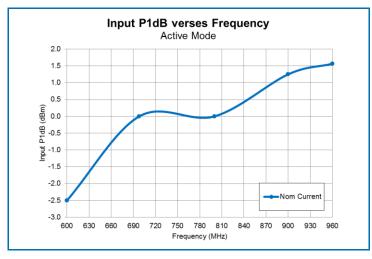


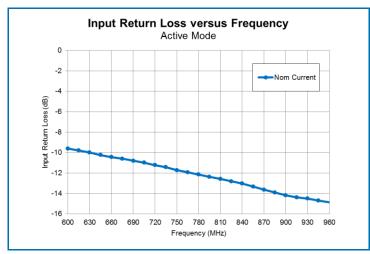


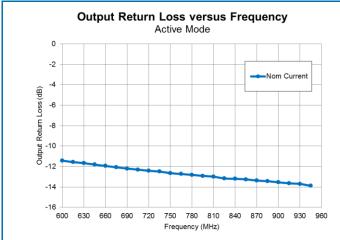


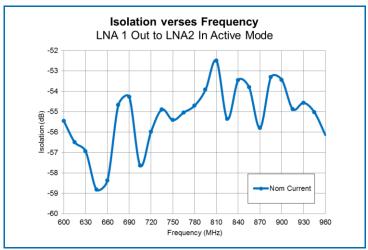


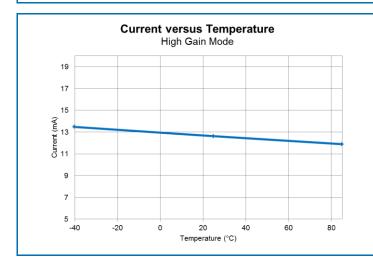
#### Typical Performance: T=25°C, VDD = 4V unless otherwise noted

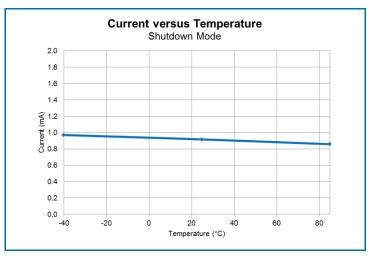








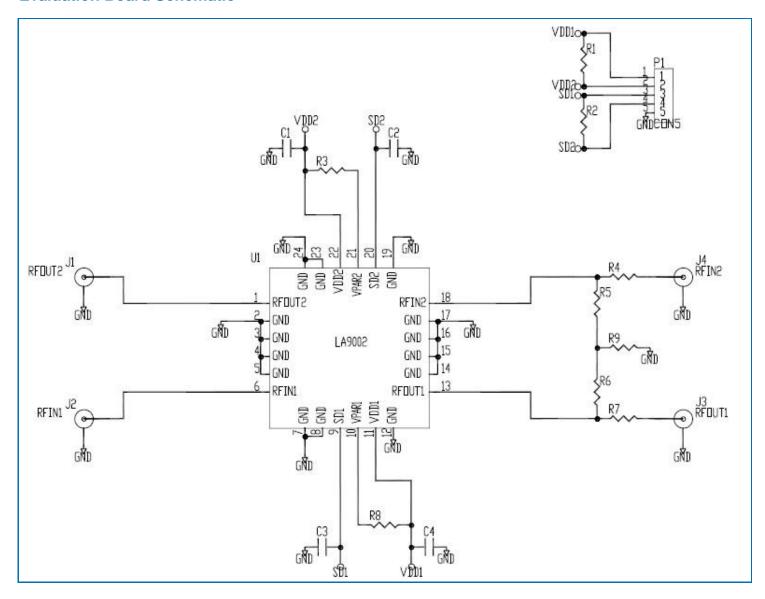




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#### **Evaluation Board Schematic**





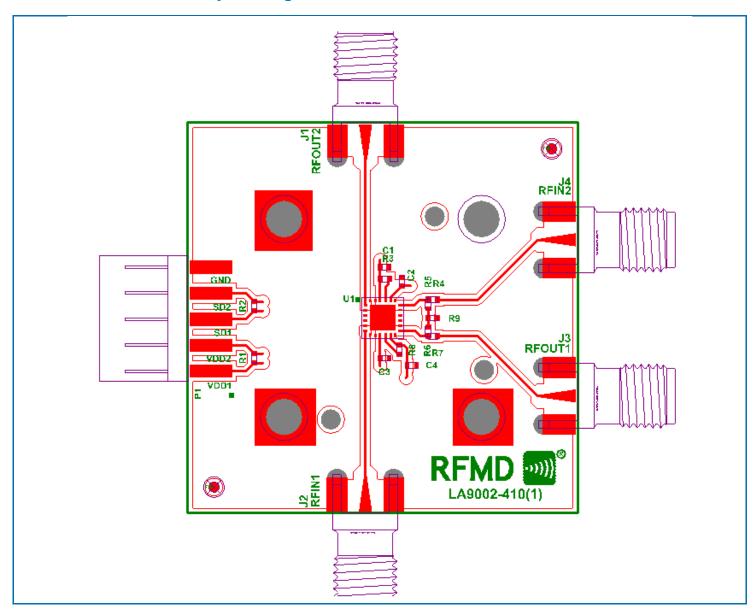
## **Evaluation Board Bill of Materials (BOM)**

Description	Reference Designator	Manufacturer	Manufacturer's P/N
Evaluation Board		DDI	LA9002-410(1)
RFLA9002 Module	U1	RFMD	RFLA9002
CAP, 1µF, 10%, 16V, X7R, 0402	C1-C4	Murata Electronics	GRM155R71C104KA88D
CONN, SMA, END LNCH, UNIV, HYB MNT, FLT	J1-J4	Heilind Electronics	PER MAT-21-1038
RES, 0Ω, 0402	R5-R6	Kamaya, Inc.	RMC1/16SJPTH
CONN, HDR, ST, PLRZD, 9-PIN	P1	ITW Pancon	MPSS100-5C
DNP	R1-R4*, R7-R9*		

Note: Parts with \* following the Reference Designators should not be populated on PCBA.



## **Evaluation Board Assembly Drawing**





## **Pin Names and Descriptions**

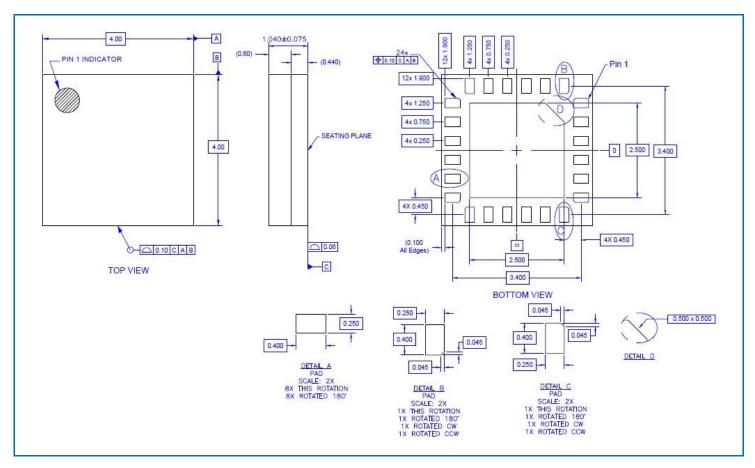
Pin	Name	Description
1	RF_OUT2	RF Output; Internally 50Ω matched and DC blocked
2	GND	Connect to low inductance path to ground
3	GND	Connect to low inductance path to ground
4	GND	Connect to low inductance path to ground
5	GND	Connect to low inductance path to ground
6	RF_IN1	RF Input; Internally 50Ω matched and DC blocked
7	GND	Connect to low inductance path to ground
8	GND	Connect to low inductance path to ground
9	SD1	Shut down pin for LNA1
10	VPAR1	Connection for external resistor to raise current when connected from this pad to V <sub>DD</sub> and to lower current when connected from this pad to ground
11	VDD	VDD supply, 10nF decoupling internal, supply for LNA1
12	GND	Connect to low inductance path to ground
13	RF_OUT1	RF Output; Internally 50Ω matched and DC blocked
14	GND	Connect to low inductance path to ground
15	GND	Connect to low inductance path to ground
16	GND	Connect to low inductance path to ground
17	GND	Connect to low inductance path to ground
18	RF_IN1	RF Input; Internally 50Ω matched and DC blocked
19	GND	Connect to low inductance path to ground
20	SD2	Shut down pin for LNA2
21	VPAR2	Connection for external resistor to raise current when connected from this pad to V <sub>DD</sub> and to lower current when connected from this pad to ground
22	VDD2	VDD supply, 10nF decoupling internal, supply for LNA2
23	GND	Connect to low inductance path to ground
24	GND	Connect to low inductance path to ground

#### **Truth Table**

	SD1	SD2
LNA1 On	0	Х
LNA1 Off	1	Х
LNA2 On	Х	0
LNA2 Off	Х	1

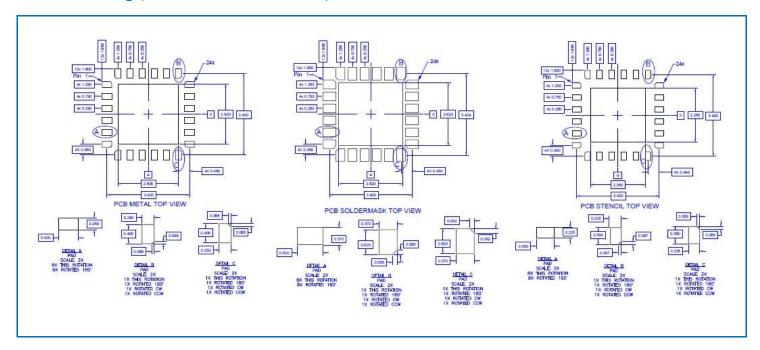


## Package Outline Drawing (Dimensions in millimeters)

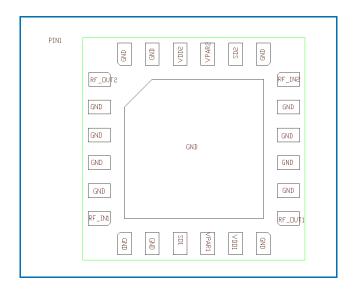




## Stencil Drawing (Dimensions in millimeters)

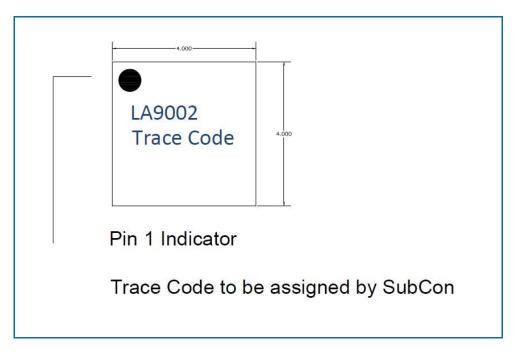


#### **Pin Out**





## **Branding Diagram**





OOO «ЛайфЭлектроникс" "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 P/C 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

#### Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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